

InGaAs area image sensors



G16561 to G16564-0909T

Near-infrared two-dimensional image sensor with 640 × 512 pixels

The G16561 to G16564-0909T have a hybrid structure consisting of a CMOS readout circuit (ROIC: readout integrated circuit) and back-illuminated InGaAs photodiodes. Each pixel is made up of an InGaAs photodiode and a ROIC electrically connected by indium bump. The timing generator in the ROIC provides an analog video output which is obtained by just supplying digital inputs. The G16561 to G16564-0909T have 640 × 512 pixels arrayed at a 20 μm pitch. Light incident on the InGaAs photodiodes is converted into electrical signals which are then input to the ROIC through indium bumps. Electrical signals in the ROIC are converted into voltage signals and then sequentially output from the video line by the shift register. The G16561 to G16564-0909T are hermetically sealed in a metal package together with a three-stage thermoelectric cooler to deliver stable operation. The dynamic range has been more than doubled compared to conventional products, and integrate while readout (IWR) and multi-line readout functions have been added.

■ Features

- Dynamic range: 3500
- 4-port analog output
- Frame rate: 116 frames/s max.
(All-line readout mode, integration time=8.59 ms, in IWR operation)
- Low dark current
- Operation of integrate while readout function and integrate then readout function can be done.
- Multi-line readout function
- Simple operation (built-in timing generator)
- Three-stage TE-cooled type

■ Applications

- Near infrared non-destructive inspection
(farm produce inspection, semiconductor inspection, etc.)
- Hyperspectral imaging
(plastic sorting, food screening, etc.)
- Traffic monitoring

■ Selection guide

| Type no. | Spectral response range (μm) |
|--------------|---------------------------------|
| G16561-0909T | 0.95 to 1.69 (15 °C) |
| G16562-0909T | 1.12 to 1.85 (-20 °C) |
| G16563-0909T | 1.3 to 2.15 (-20 °C) |
| G16564-0909T | 1.7 to 2.55 (-20 °C) |

■ Structure

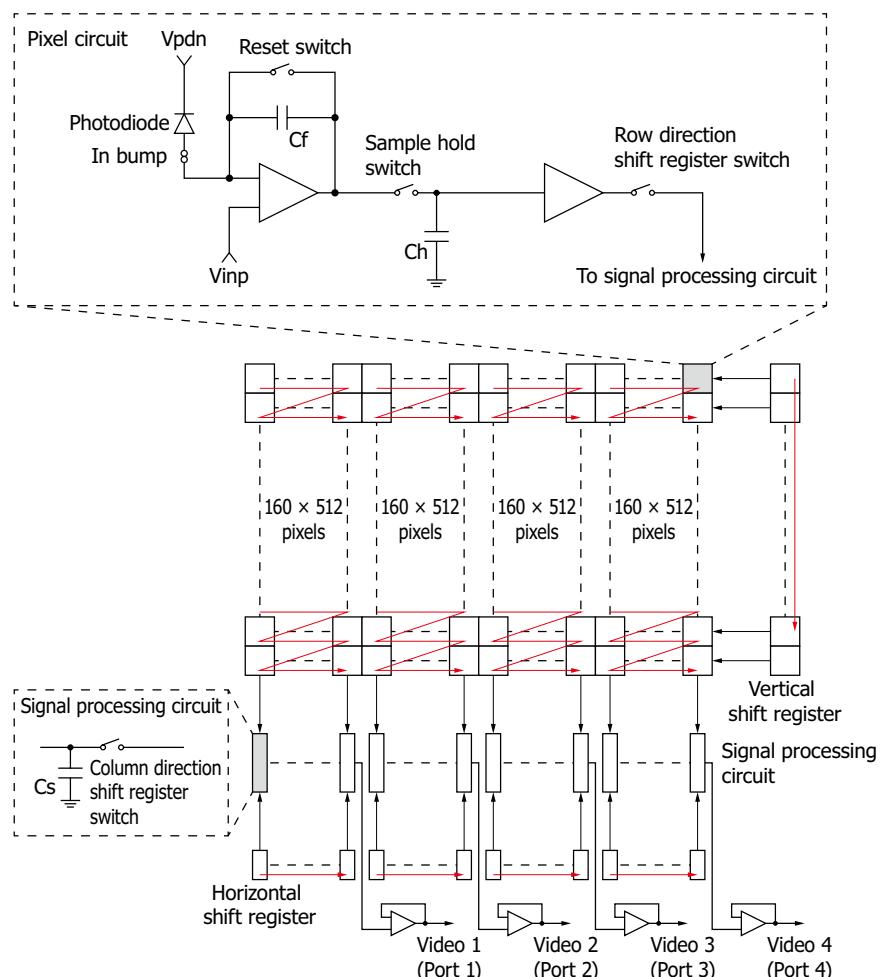
| Parameter | Specification | Unit |
|----------------------------|--------------------------------|--------|
| Image size | 12.80 × 10.24 | mm |
| Cooling | Three-stage TE-cooled | - |
| Total number of pixels | 640 × 512 (327680) | pixels |
| Number of effective pixels | 640 × 512 (327680) | pixels |
| Pixel size | 20 × 20 | μm |
| Pixel pitch | 20 | μm |
| Fill factor | 100 | % |
| Package | 28-pin metal | - |
| Window material | Sapphire glass with AR coating | - |

Block diagram

The series of operations of the readout circuit are described below.

G16561 to G16564-0909T can support both integrate while readout mode (IWR) and integrate then readout mode(ISTR) by switching the input timing.

- 1) Turn on the reset switch to reset.
- 2) After turning off the reset switch, turn on the sample hold switch to start integration. Pixel optical signal information is integrated in the capacitance Cf as a signal voltage.
- 3) Turn off the sample hold switch to end the integration. The pixel signal voltage is held in the capacitance Ch.
- 4) Turn on the reset switch to reset the pixel signal voltage integrated in the capacitance Cf.
- 5) The vertical shift register turns on the row direction shift register switch in the first row, and the signal voltage is transferred to the capacitance Cs.
- 6) The horizontal shift register turns on the column direction shift register switch in the first row and first column of each port.
- 7) The next column is selected by the horizontal shift register of each port, and the output signals (Video1 to 4) are read out sequentially.
- 8) Repeat steps 5 to 7 for each row. (When doing the IWR operation, turn off the reset switch and start integration.)
- 9) To perform the next integration, return to step 2.



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Absolute maximum ratings

| Parameter | Symbol | Condition | Value | Unit |
|--|-----------------------|-----------|--------------|------|
| Supply voltage (5 V) | Vdd1, Vb1, Vinp, Vpdn | Ta=25 °C | -0.3 to +6.0 | V |
| Supply voltage (3.3 V) | Vdd2, Vrst | Ta=25 °C | -0.3 to +4.2 | V |
| Input signal voltage | Vi | Ta=25 °C | -0.3 to +4.2 | V |
| Operating temperature*1, 2 | Topr | | -30 to +60 | °C |
| Storage temperature*2 | Tstg | | -40 to +70 | °C |
| Allowable current of TE-cooler*3, 4 | ITE max | | 3.5 | A |
| Allowable voltage of TE-cooler*3, 5 | VTE max | | 7.8 | V |
| Thermistor power dissipation | Pd_th | | 400 | mW |
| Maximum temperature of heat radiation side*6 | - | | 70 | °C |

*1: Chip temperature

*2: No dew condensation

When there is a temperature difference between a product and the ambient in high humidity environment, dew condensation may occur on the product surface. Dew condensation on the product may cause a deterioration of characteristics and reliability.

*3: Th=25 °C, Th is the temperature on the heat dissipation side of the built-in Peltier element.

*4: The current value that provides the maximum temperature difference between the heat absorption side and heat dissipation side of the Peltier element in a completely insulated state. We recommend using it at 80 % of the maximum current value due to the load on the Peltier element and stability of temperature.

*5: The voltage required between the Peltier element terminals to allow maximum current to flow.

*6: If the temperature on the heat dissipation side exceeds this temperature, the Peltier element may degrade.

Note: Exceeding the absolute maximum ratings even momentarily may cause a drop in product quality. Always be sure to use the product within the absolute maximum ratings.

Electrical and optical characteristics

(Ta=25 °C, Vdd1=5.0 V, Vdd2=3.3 V, Vpdn=3.18 V, Vinp=3.1 V, Vrst=1.7 V, fop=50 MHz)

| Parameter | Symbol | G16561-0909T*7 | | | G16562 to G16564-0909T*8 | | | Unit |
|--|--------|----------------|--------------|-------|--------------------------|------|--------------|------|
| | | Min. | Typ. | Max. | Type no. | Min. | Typ. | |
| Spectral response range | λ | - | 0.95 to 1.69 | - | G16562 | - | 1.12 to 1.85 | - |
| | | | | | G16563 | - | 1.3 to 2.15 | - |
| | | | | | G16564 | - | 1.7 to 2.55 | - |
| Peak sensitivity wavelength | λp | - | 1.55 | - | G16562 | - | 1.75 | - |
| | | | | | G16563 | - | 1.95 | - |
| | | | | | G16564 | - | 2.2 | - |
| Photosensitivity ($\lambda=\lambda p$) | S | 0.7 | 0.8 | | G16562 | 0.9 | 1.1 | - |
| | | | | | G16563 | 0.85 | 1.0 | - |
| | | | | | G16564 | 0.8 | 1.0 | - |
| Conversion efficiency | CE | - | 2.0 | - | | - | 2.0 | - |
| Saturation charge | Csat | 0.8 | 1.05 | - | | 0.8 | 1.05 | - |
| Saturation output voltage | Vsat | 1.6 | 2.1 | - | | 1.6 | 2.1 | - |
| Photoresponse nonuniformity*9 | PRNU | - | ±10 | ±20 | | - | ±10 | ±30 |
| | | | | | G16562 | - | 0.3 | 3 |
| Dark current | ID | - | 0.03 | 0.3 | G16563 | - | 3 | 30 |
| | | | | | G16564 | - | 30 | 300 |
| Dark output nonuniformity*10 | DSNU | - | ±0.02 | ±0.12 | | - | ±0.1 | ±0.6 |
| Readout noise*11 | Nread | - | 600 | 1400 | | - | 600 | 1400 |
| | | - | 300 | 700 | | - | 300 | 700 |
| Dynamic range | Drange | 1500 | 3500 | - | | 1500 | 3500 | - |
| Defective pixels*12 | - | - | - | 0.37 | | - | - | 1 |

*7: Tchip=15 °C

*8: Tchip=-20 °C

*9: Measured at 50 % saturation after subtracting the dark output, excluding the first and last pixels of each row

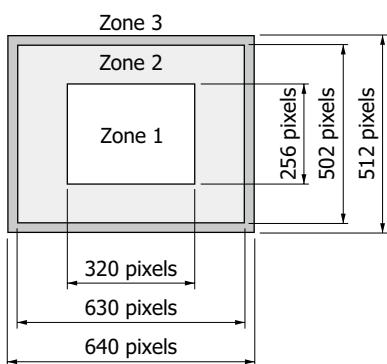
G16561/G16562-0909T: Integration time=2 ms, G16563-0909T: Integration time=0.5 ms, G16564-0909T: Integration time=0.05 ms

*10: G16561-0909T, G16562-0909T: Integration time=2 ms, G16563-0909T: Integration time=0.5 ms, G16564-0909T: Integration time=0.05 ms

*11: Integration time=19.82 μs

*12: Pixels whose saturation output voltage, photoresponse nonuniformity, dark current, dark output nonuniformity, or readout noise is outside the specifications (Zone 1 + 2 + 3)

[Zone definitions]



[Defective pixels in each zone]

G16561-0909T

| Zone | Maximum number of defective pixels | Percentage of defective pixels |
|------|------------------------------------|--------------------------------|
| 1 | 164 | 0.2 % |
| 2 | 469 | 0.2 % |
| 3 | 571 | 5 % |

G16562 to G16564-0909T

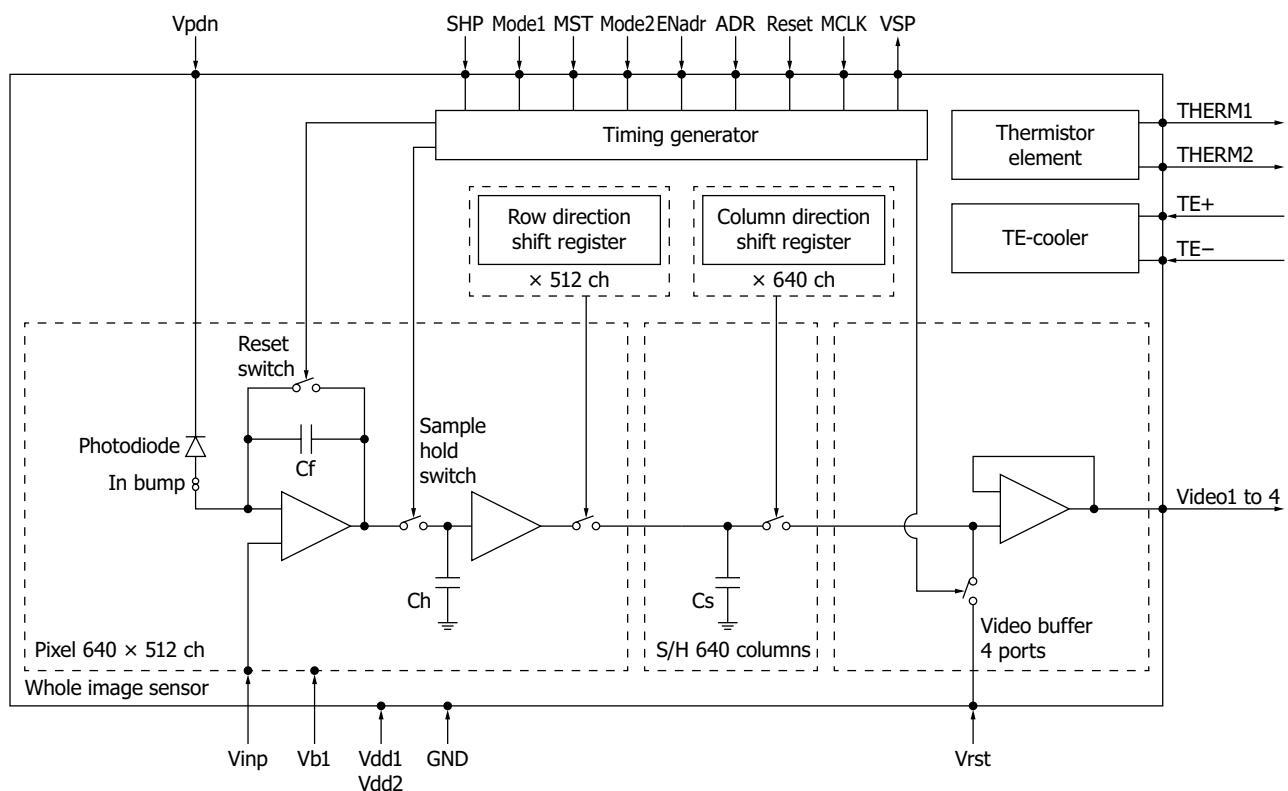
| Zone | Maximum number of defective pixels | Percentage of defective pixels |
|------|------------------------------------|--------------------------------|
| 1 | 492 | 0.6 % |
| 2 | 1406 | 0.6 % |
| 3 | 1713 | 15 % |

[Consecutive defective pixels]

The number of consecutive adjacent defect pixels is less than 16.

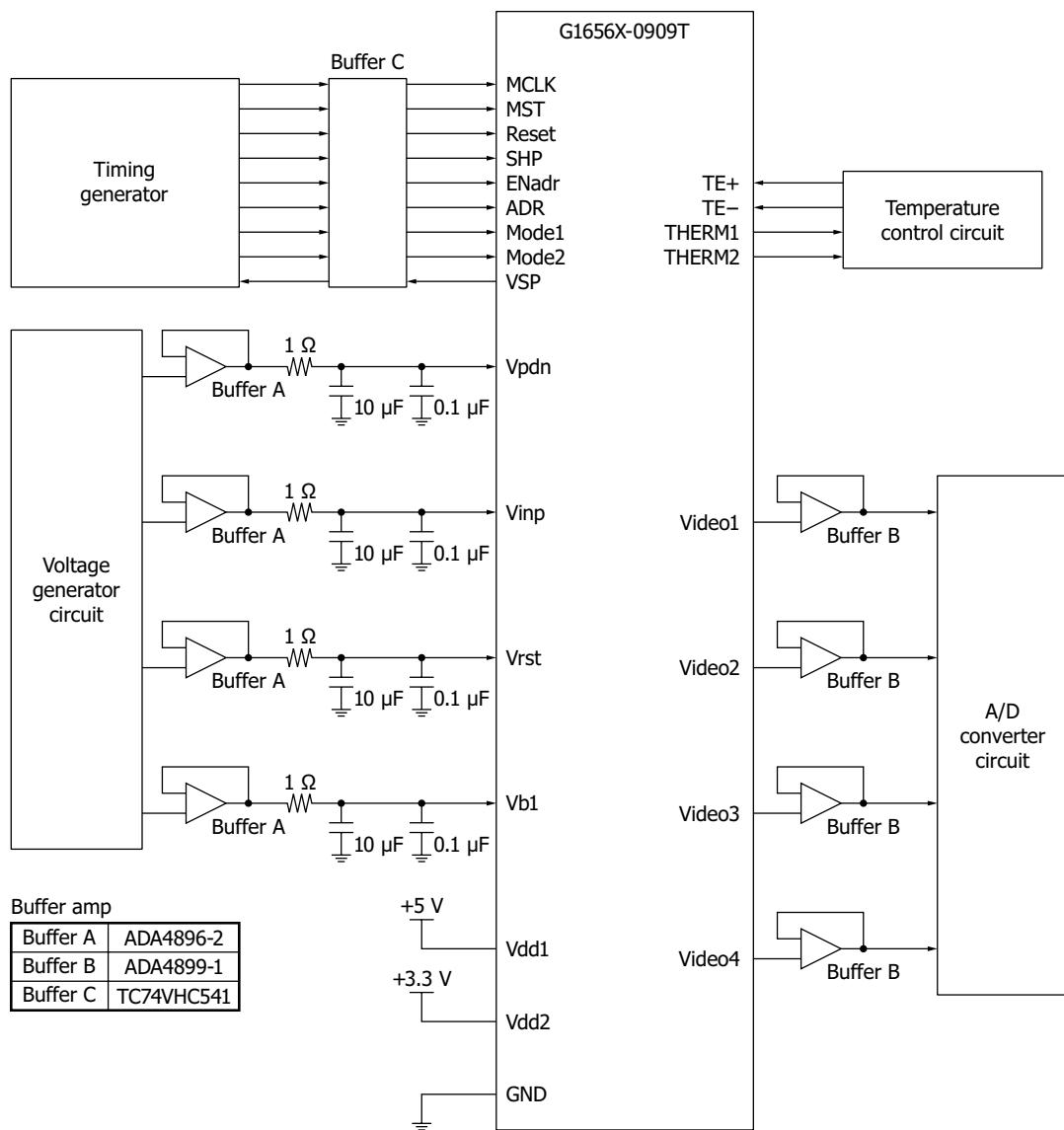
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■ Equivalent circuit



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Connection example



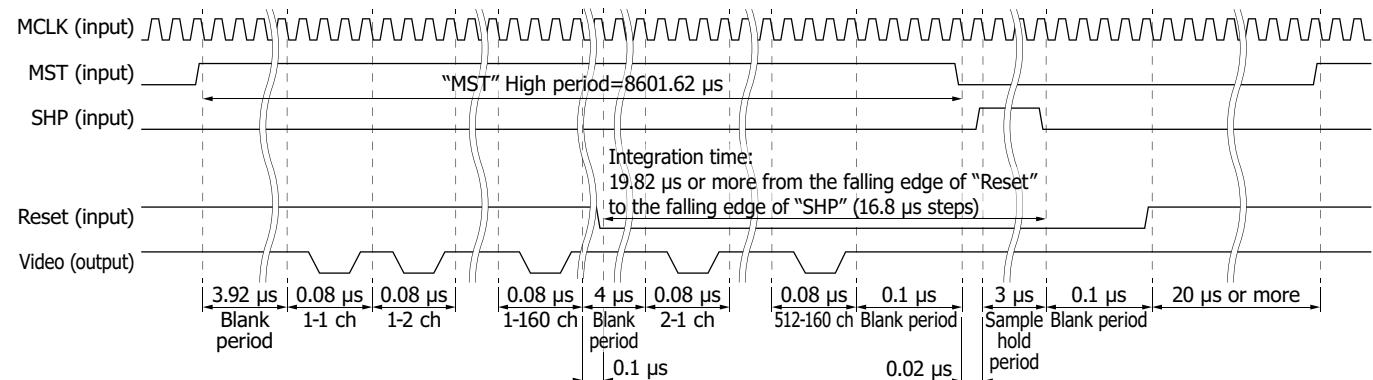
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Timing chart

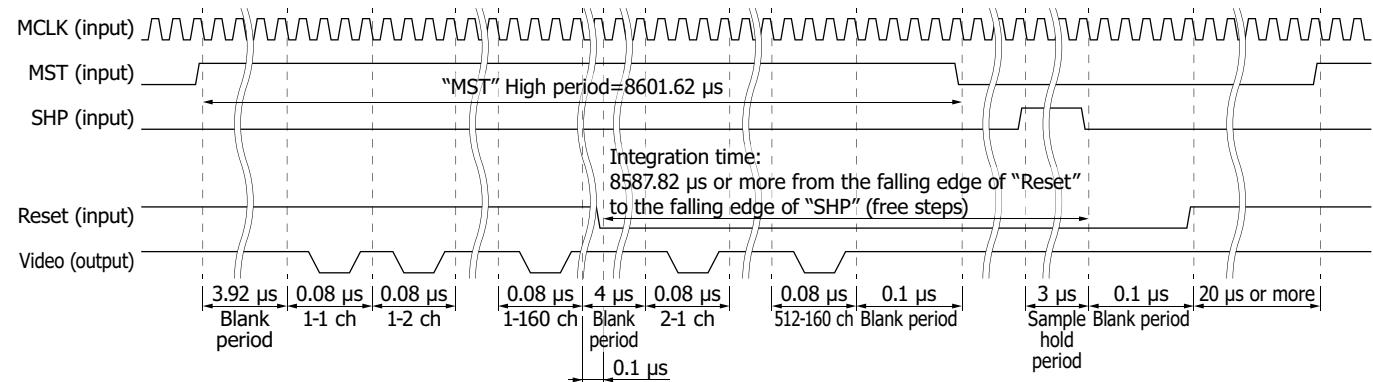
G16561 to G16564-0909T can support both integrate while readout mode (IWR) and integrate then readout mode (ITR) by switching the input timing. For details, see the timing chart.

All-line readout mode_IWR mode

IWR all-line readout mode [MCLK frequency: 50 MHz, falling period, "Mode2" setting: 3.3 V (High)]
Case (1) Integration time<readout period (when integration time is 19.82 μ s to 8587.82 μ s)



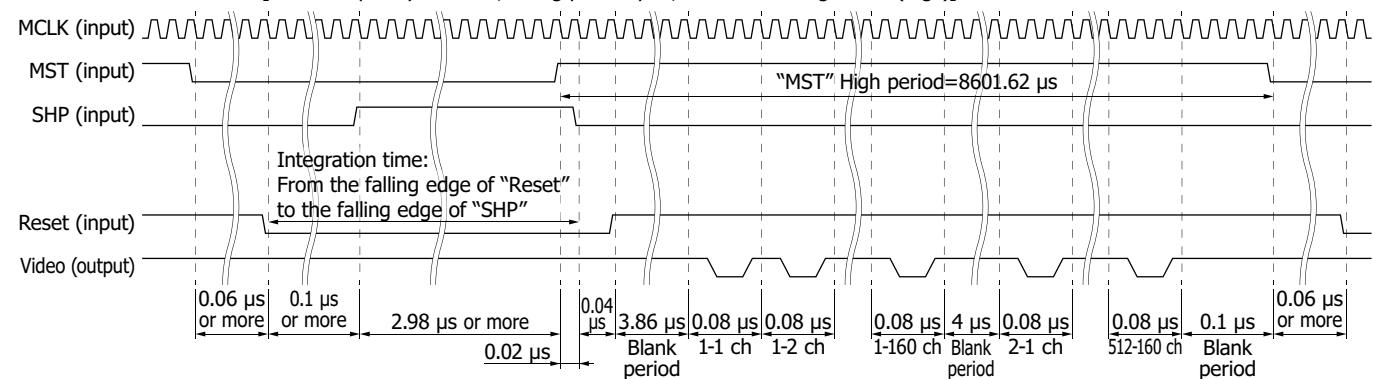
Case (2) Integration time>readout period (when integration time is 8587.82 μ s or more)



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All-line readout mode_ITR mode

ITR all-line readout mode [MCLK frequency: 50 MHz, falling period/cycle, "Mode2" setting: 3.3 V (High)]

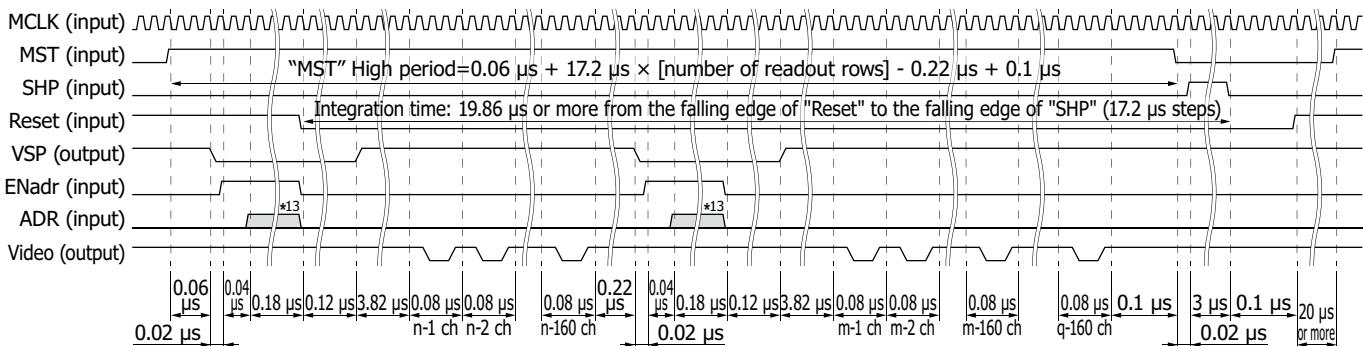


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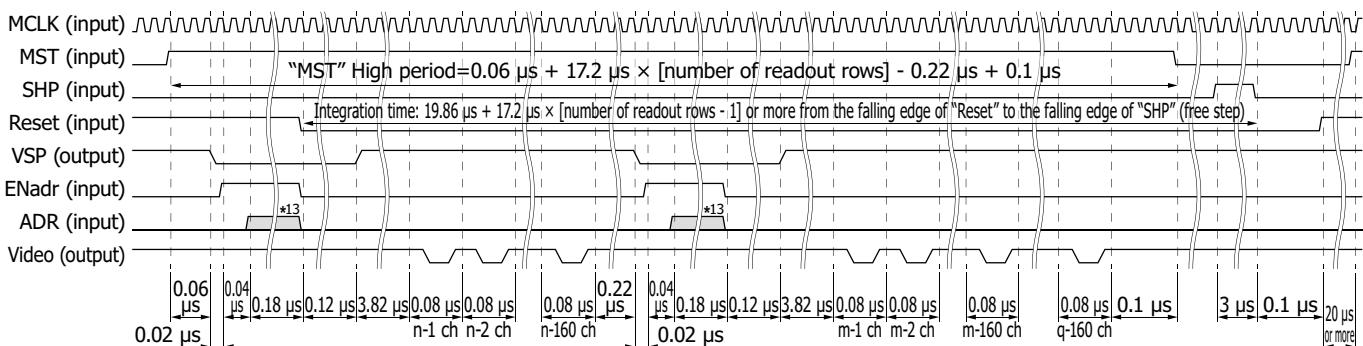
■ Multi-line readout mode_IWR mode

IWR multi-line readout mode [MCLK frequency: 50 MHz, falling period, "Mode2" setting: 0 V (Low)]

Case (1) Integration time < readout period (when integration time is 19.86 μ s to 19.86 μ s + 17.2 μ s × [number of readout rows - 1])



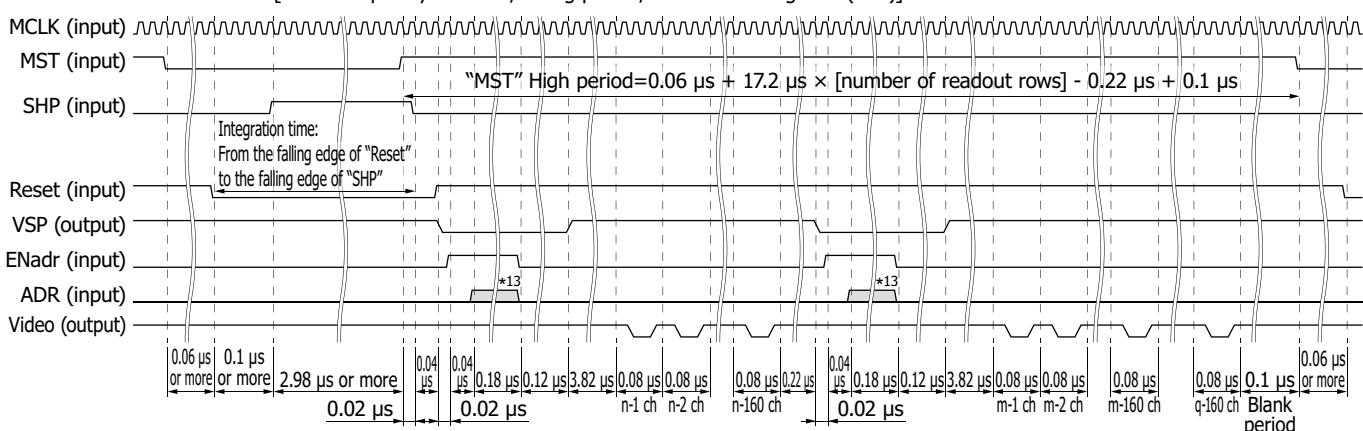
Case (2) Integration time > readout period (when integration time is 19.86 μ s + 17.2 μ s × [number of readout rows - 1])



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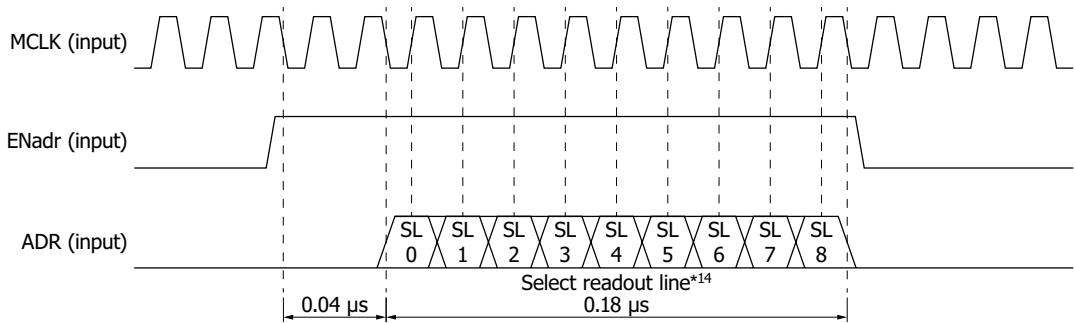
■ Multi-line readout mode_ITR mode

ITR multi-line readout mode [MCLK frequency: 50 MHz, falling period, "Mode2" setting: 0 V (Low)]



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*13: ADR signal setting of multi-line readout mode



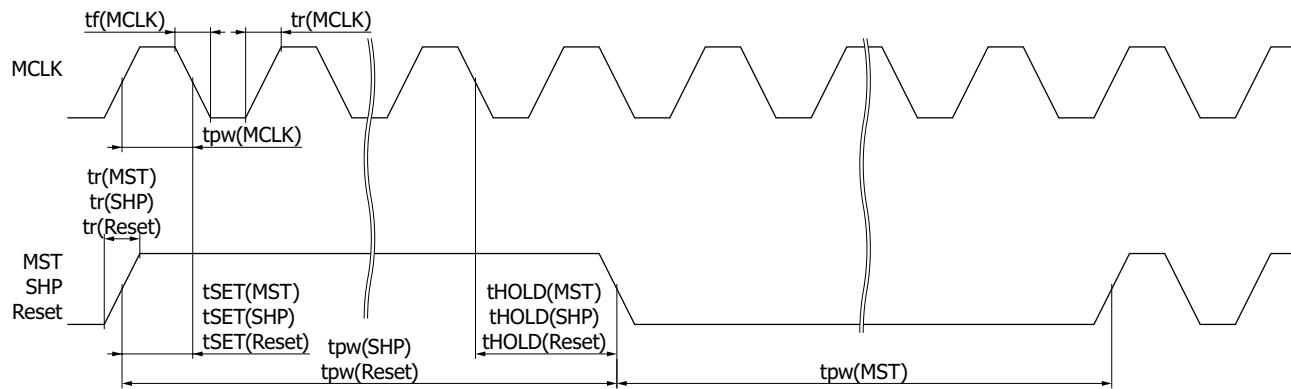
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*14: ADR signal setting example

| Select Line Row-ch | SL Address Decimal | SL Address Binary | SL0 | SL1 | SL2 | SL3 | SL4 | SL5 | SL6 | SL7 | SL8 |
|--------------------|--------------------|-------------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| 1 | 0 | 000000000 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 11 | 10 | 000001010 | 0 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | 0 |
| 129 | 128 | 010000000 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 |
| 256 | 255 | 011111111 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 |
| 342 | 341 | 101010101 | 1 | 0 | 1 | 0 | 1 | 0 | 1 | 0 | 1 |
| 454 | 453 | 111000101 | 1 | 0 | 1 | 0 | 0 | 0 | 1 | 1 | 1 |
| 512 | 511 | 111111111 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |

■ Timing specifications (MCLK, MST, SHP, Reset)

Timing specifications of external input signals (MCLK, MST, SHP, Reset) are shown below.



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■ Specifications of external input signal (MCLK, MST, SHP, Reset)

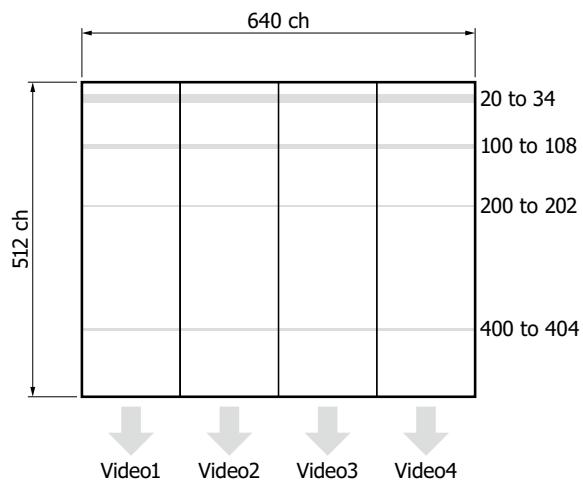
| Parameter | Symbol | Min. | Typ. | Max. | Unit |
|---|--|------|------|------|------|
| Clock frequency | fop | - | - | 50 | MHz |
| Clock pulse width | tpw(MCLK) | 10 | - | - | ns |
| Clock pulse rise/fall times | tr(MCLK), tf(MCLK) | - | 3 | 4 | ns |
| MST pulse width | tpw(MST) | 40 | - | - | ns |
| SHP pulse width | tpw(SHP) | 1000 | - | - | ns |
| Reset pulse width | tpw(Reset) | 1000 | - | - | ns |
| MST rise/fall times SHP rise/fall times Reset rise/fall times | tr(MST), tf(MST), tr(SHP), tf(SHP), tr(Reset), tf(Reset) | - | 3 | 4 | ns |
| Setup time | tSET(MST), tSET(SHP), tSET(Reset) | 5 | - | - | ns |
| Hold time | tHOLD(MST), tHOLD(SHP), tHOLD(Reset) | 5 | - | - | ns |

■ Multi-line readout mode

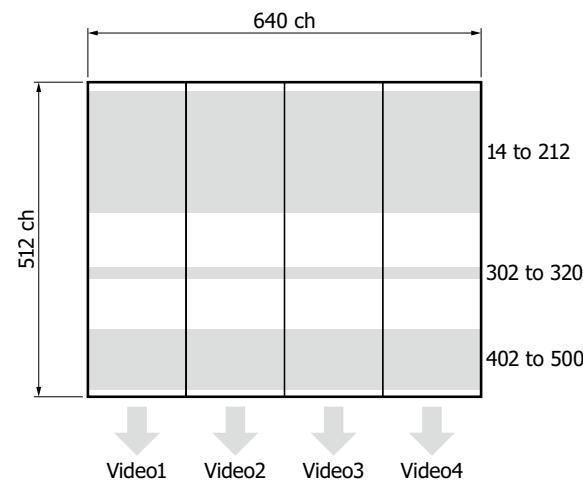
G16561 to G16564-0909T can be set to multi-line readout mode in addition to normal readout mode (all-line readout mode). By setting to the multi-line readout mode, it is possible to freely read any row (multi-line readout mode). To set the readout row, it is necessary to input an external signal to the specified terminal (ADR, ENadr). For details, see "Timing chart of multi-line readout mode".

■ Readout example of multi-line readout mode

(a) Selected rows 20 to 34, 100 to 108, 200 to 202, 400 to 404 (total 32 rows)



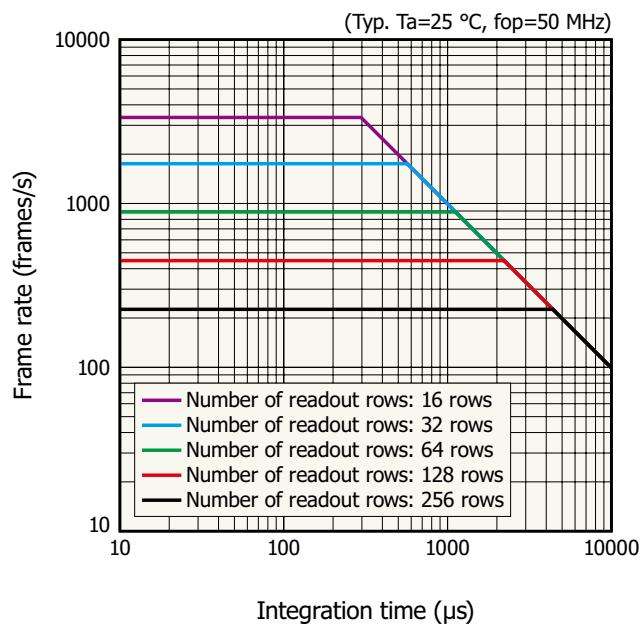
(b) Selected rows 14 to 212, 302 to 320, 402 to 500 (total 317 rows)



: readout region

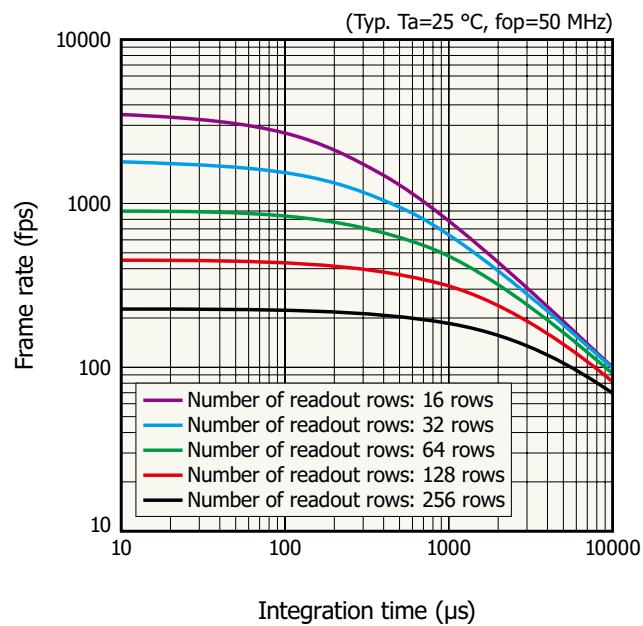
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■ Multi-line readout mode_frame rate in IWR operation



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■ Multi-line readout mode_frame rate in ITR operation



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■ Recommended drive conditions ($T_a=25\text{ }^{\circ}\text{C}$)

| Parameter | | Symbol | Min. | Typ. | Max. | Unit |
|--|-------------------|-----------|-------------|-------------|-------------|------|
| Supply voltage | Vdd1 | 4.9 | 5.0 | 5.1 | V | |
| | Vdd2 | 3.2 | 3.3 | 3.4 | V | |
| Supply current | Ivdd1 | - | 110 | 220 | mA | |
| | Ivdd2 | - | 30 | 60 | mA | |
| First-stage amplifier reference voltage ^{*15} | Supply voltage | Vinp | 3.0 | 3.1 | 3.2 | V |
| | Supply current | Ivinp | - | - | 10 | mA |
| Video line reset voltage | Supply voltage | Vrst | 1.6 | 1.7 | 1.8 | V |
| | Supply current | Ivrst | - | - | 10 | mA |
| Element bias voltage ^{*15} | Supply voltage | Vpdn | 3.08 | Vinp + 0.08 | 3.28 | V |
| | Supply current | Ivpdn | - | - | 20 | mA |
| Pixel bias voltage ^{*16} | Supply voltage | Vb1 | 2.5 | 3.5 | 4.5 | V |
| | Supply current | Ivb1 | - | - | 10 | mA |
| MCLK voltage | High | Vi(MCLK) | Vdd2 - 0.25 | Vdd2 | Vdd2 + 0.25 | V |
| | Low | | - | - | 0.25 | |
| MST voltage | High | Vi(MST) | Vdd2 - 0.25 | Vdd2 | Vdd2 + 0.25 | V |
| | Low | | - | - | 0.25 | |
| SHP voltage | High | Vi(SHP) | Vdd2 - 0.25 | Vdd2 | Vdd2 + 0.25 | V |
| | Low | | - | - | 0.25 | |
| Reset voltage | High | Vi(Reset) | Vdd2 - 0.25 | Vdd2 | Vdd2 + 0.25 | V |
| | Low | | - | - | 0.25 | |
| ENadr voltage | High | Vi(ENadr) | Vdd2 - 0.25 | Vdd2 | Vdd2 + 0.25 | V |
| | Low | | - | - | 0.25 | |
| ADR voltage | High | Vi(ADR) | Vdd2 - 0.25 | Vdd2 | Vdd2 + 0.25 | V |
| | Low | | - | - | 0.25 | |
| Mode1 voltage ^{*17} | High | Vi(Mode1) | Vdd2 - 0.25 | Vdd2 | Vdd2 + 0.25 | V |
| | Low | | - | - | 0.25 | |
| Mode2 voltage ^{*18} | High | Vi(Mode2) | Vdd2 - 0.25 | Vdd2 | Vdd2 + 0.25 | V |
| | Low | | - | - | 0.25 | |
| Video output voltage | Dark output | Vs(dark) | 2.2 | 2.4 | 2.6 | V |
| | Saturation output | Vs(sat) | 0.1 | 0.3 | 0.5 | |
| Output impedance | | Zo | - | 1 | - | kΩ |
| Clock frequency | | fop | - | - | 50 | MHz |
| Data rate | | DR | - | fop/4 | - | Hz |
| Frame rate (fop=50 MHz) ^{*19} | | FR | - | - | 116 | fps |

*15: Set Vpdn to a higher voltage than Vinp.

*16: Setting values vary depending on the sample. For the setting value, refer to the Vb1 value written on the final inspection sheet enclosed at the time of shipment.

*17: Set to 3.3 V.

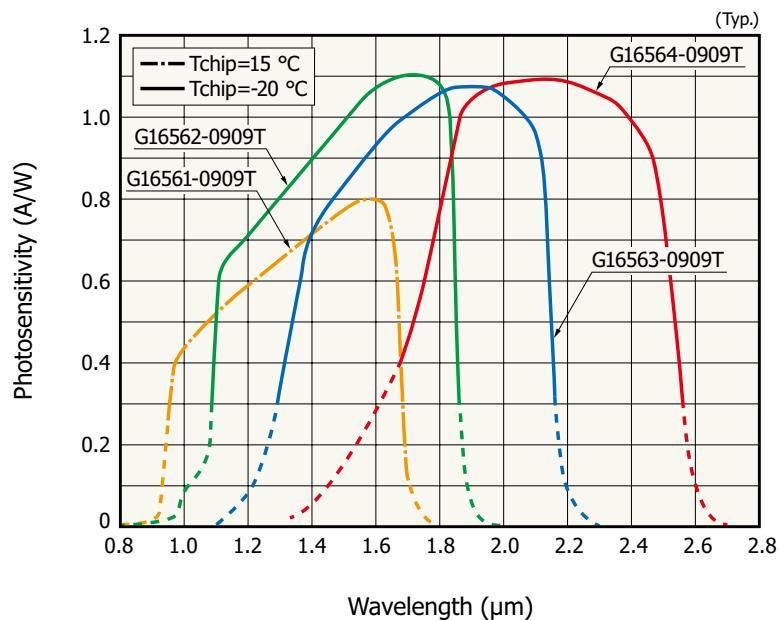
*18: High (3.3 V): All-line readout mode, Low (0 V): Multi-line readout mode

*19: All-line readout mode, integration time=8587.82 μs, in IWR operation

■ Operation mode selection

| Terminal name | Pin no. | Input | Description |
|---------------|---------|-----------------------------|--|
| Mode1 | 17 | High=3.3 V [Vdd2(3.3 V)] | Apply the fixed voltage indicated on the left. |
| Mode2 | 25 | High=3.3 V [Vdd2(3.3 V)] | All-line readout mode |
| | | Low=0 V (GND) | Multi-line readout mode |

■ Spectral response



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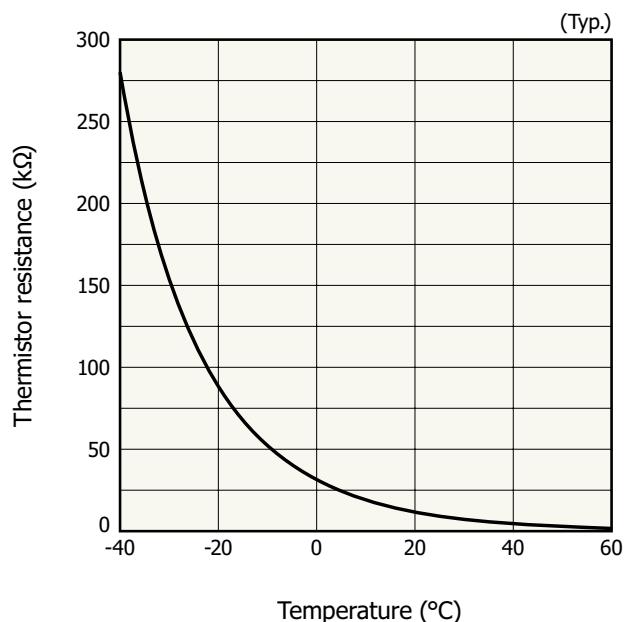
■ Specifications of built-in TE-cooler/thermistor (Ta=25 °C)

| Parameter | Symbol | Condition | Min. | Typ. | Max. | Unit |
|---|--------|---------------------|------|------|------|------|
| Recommended TE-cooler operating current | ITE | | - | - | 2.8 | A |
| Recommended TE-cooler operating voltage | VTE | | - | - | 6.2 | V |
| Temperature difference* ²⁰ | ΔT | ITE=2.8 A, Ta=25 °C | 50 | - | - | °C |
| Thermistor resistance | Rth | Tchip=25 °C | 9 | 10 | 11 | kΩ |
| Thermistor B constant | B | * ²¹ | - | 3660 | - | K |

*20: Temperature difference between the photosensitive area and package heat dissipation area

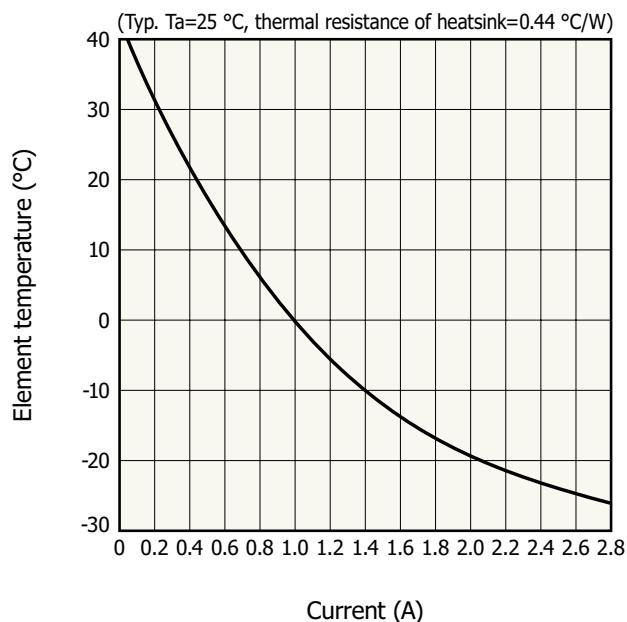
*21: T1=25 °C, T2=-20 °C

Thermistor temperature characteristics



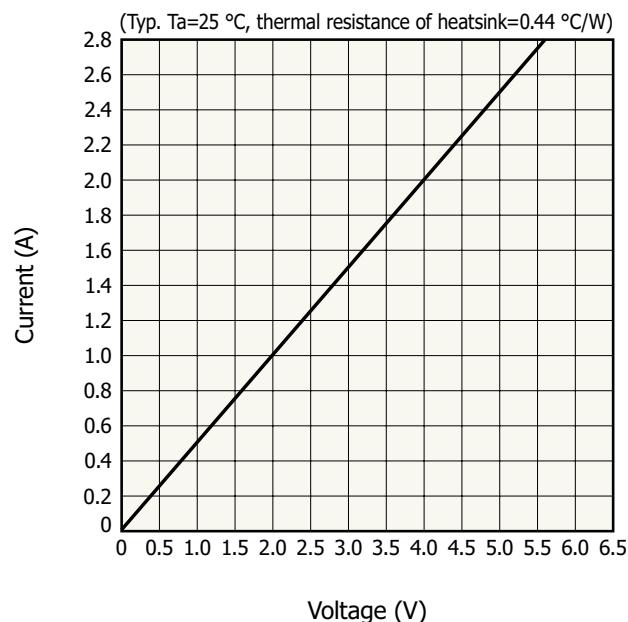
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Cooling characteristics of TE-cooler



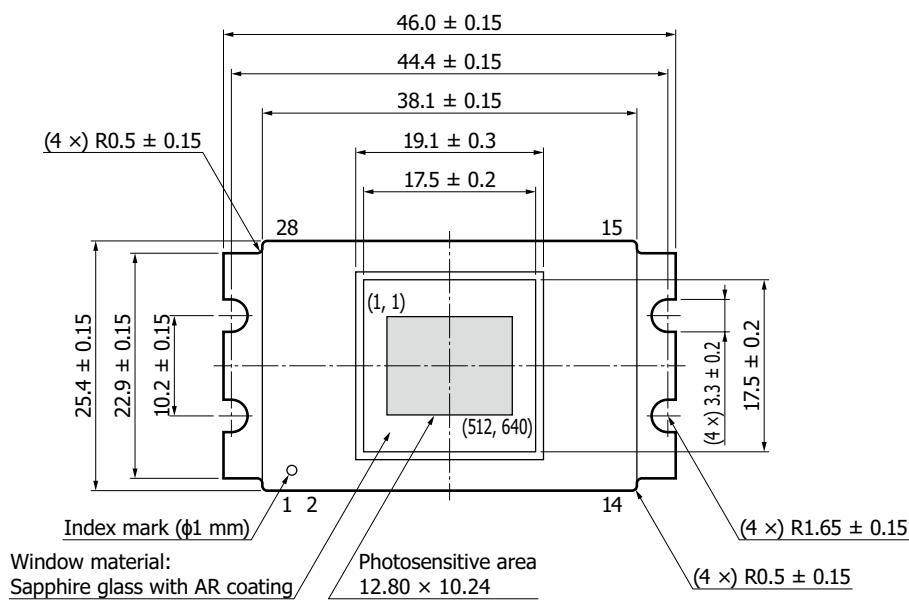
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Current vs. voltage characteristics of TE-cooler

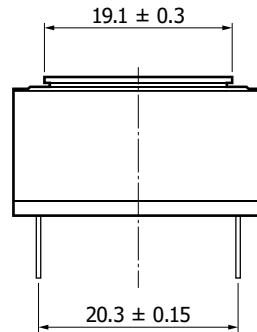
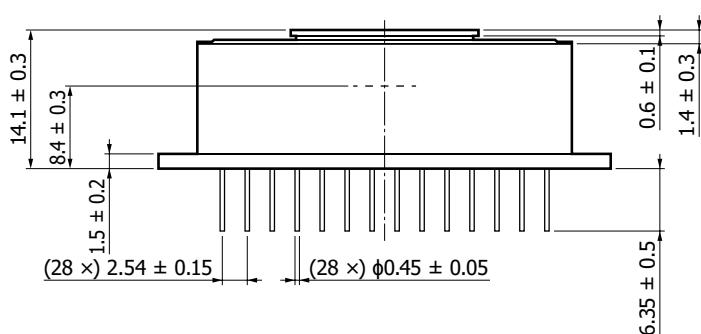


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Dimensional outline (unit: mm)



| Pin No. | Symbol | Pin No. | Symbol |
|---------|--------|---------|--------|
| 1 | TE+ | 15 | Vdd1 |
| 2 | GND | 16 | Vdd2 |
| 3 | Vpdn | 17 | Mode1 |
| 4 | Vb1 | 18 | VSP |
| 5 | Vinp | 19 | ADR |
| 6 | Vrst | 20 | SHP |
| 7 | Video1 | 21 | MST |
| 8 | NC | 22 | MCLK |
| 9 | Video2 | 23 | Reset |
| 10 | NC | 24 | ENadr |
| 11 | Video3 | 25 | Mode2 |
| 12 | NC | 26 | THERM1 |
| 13 | Video4 | 27 | THERM2 |
| 14 | NC | 28 | TE- |



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Pin connections

| Pin no. | Symbol | Input/output | Description | Note |
|---------|--------|--------------|--|---|
| 1 | TE+ | Input | TE-cooler (+) | - |
| 2 | GND | Input | 0 V ground | 0 V |
| 3 | Vpdn | Input | Photodiode bias voltage | 3.18 V Typ. |
| 4 | Vb1 | Input | Pixel bias voltage | 2.5 V to 4.5 V |
| 5 | Vinp | Input | Charge amplifier reset voltage | 3.1 V Typ. |
| 6 | Vrst | Input | Video line reset voltage | 1.7 V Typ. |
| 7 | Video1 | Output | Video output after integration (port 1) | 0.1 V to 2.6 V |
| 8 | NC | - | - | - |
| 9 | Video2 | Output | Video output after integration (port 2) | 0.1 V to 2.6 V |
| 10 | NC | - | - | - |
| 11 | Video3 | Output | Video output after integration (port 3) | 0.1 V to 2.6 V |
| 12 | NC | - | - | - |
| 13 | Video4 | Output | Video output after integration (port 4) | 0.1 V to 2.6 V |
| 14 | NC | - | - | - |
| 15 | Vdd1 | Input | +5 V power supply | +5 V |
| 16 | Vdd2 | Input | +3.3 V power supply | +3.3 V |
| 17 | Mode1 | Input | Mode switching signal | Set to High (3.3 V) |
| 18 | VSP | Output | Synchronization signal for multi-line readout mode | - |
| 19 | ADR | Input | Control pulse for multi-line readout mode | - |
| 20 | SHP | Input | Sample hold pulse | - |
| 21 | MST | Input | Frame scan start pulse | - |
| 22 | MCLK | Input | Clock pulse for timing generator | - |
| 23 | Reset | Input | Charge amplifier reset pulse | - |
| 24 | ENadr | Input | Control pulse for multi-line readout mode | - |
| 25 | Mode2 | Input | Mode switching signal | High (3.3 V): all-line readout mode Low (0 V): multi-line readout mode |
| 26 | THERM1 | Output | Thermistor | - |
| 27 | THERM2 | Output | Thermistor | - |
| 28 | TE- | Input | TE-cooler (-) | - |

Precautions

(1) Electrostatic countermeasures

This device has a built-in protection circuit against static electrical charges. However, to prevent destroying the device with electrostatic charges, take countermeasures such as grounding yourself, the workbench and tools to prevent static discharges. Also protect this device from surge voltages which might be caused by peripheral equipment.

(2) Incident window

If there is dust or stain on the light incident window, it will show up as black blemishes on the image. When cleaning, avoid rubbing the window surface with dry cloth, dry cotton swab or the like, since doing so may generate static electricity. Use soft cloth, paper or a cotton swab, or the like moistened with alcohol to wipe off dust and stain. Then blow compressed air onto the window surface so that no stain remains.

(3) Soldering

To prevent damaging the device during soldering, take precautions to prevent excessive soldering temperatures and times. Soldering should be performed within 10 seconds at a soldering temperature below 260 °C.

(4) Operating and storage environments

Handle the device within the temperature range specified in the absolute maximum ratings. Operating or storing the device at an excessively high temperature and humidity may cause variations in performance characteristics and must be avoided.

Related information

www.hamamatsu.com/sp/ssd/doc_en.html

Precautions

- Disclaimer
- Safety consideration
- Image sensors

Catalogs

- Selection guide / InGaAs image sensors
- Technical note / InGaAs area image sensors

Information described in this material is current as of September 2025.

Product specifications are subject to change without prior notice due to improvements or other reasons. This document has been carefully prepared and the information contained is believed to be accurate. In rare cases, however, there may be inaccuracies such as text errors. Before using these products, always contact us for the delivery specification sheet to check the latest specifications.

The product warranty is valid for one year after delivery and is limited to product repair or replacement for defects discovered and reported to us within that one year period. However, even if within the warranty period we accept absolutely no liability for any loss caused by natural disasters or improper product use. Copying or reprinting the contents described in this material in whole or in part is prohibited without our prior permission.

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